

1 General description

The 74LVC2G04 provides the dual inverting buffer.

Inputs can be driven from either 3.3 V or 5 V devices. These features allow the use of these devices in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2 Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant inputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- ± 24 mA output drive ($V_{CC} = 3.0$ V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to $+85$ °C and -40 °C to $+125$ °C.

3 Ordering information

Table 1. Ordering information

Type number	Package				Version
	Temperature range	Name	Description		
74LVC2G04GW	-40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads		SOT363
74LVC2G04GV	-40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads		SOT457
74LVC2G04GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm		SOT886
74LVC2G04GF	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm		SOT891
74LVC2G04GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm		SOT1115
74LVC2G04GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm		SOT1202
74LVC2G04GX	-40 °C to +125 °C	X2SON6	plastic thermal extremely thin small outline package; no leads; 6 terminals; body 1 × 0.8 × 0.35 mm		SOT1255

4 Marking

Table 2. Marking

Type number	Marking code ^[1]
74LVC2G04GW	V4
74LVC2G04GV	V04
74LVC2G04GM	V4
74LVC2G04GF	V4
74LVC2G04GN	V4
74LVC2G04GS	V4
74LVC2G04GX	V4

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5 Functional diagram

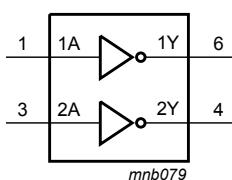


Figure 1. Logic symbol

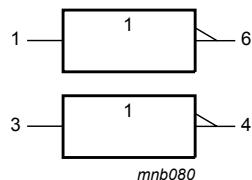


Figure 2. IEC logic symbol

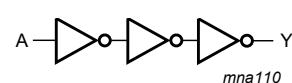


Figure 3. Logic diagram (one gate)

6 Pinning information

6.1 Pinning

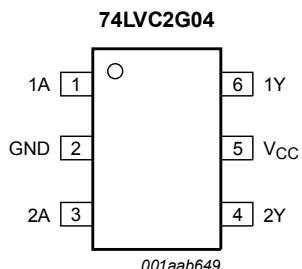


Figure 4. Pin configuration SOT363 and SOT457

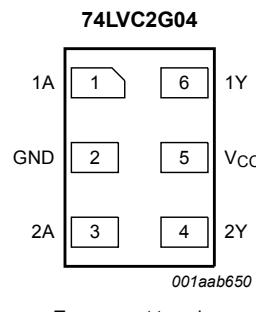


Figure 5. Pin configuration SOT886

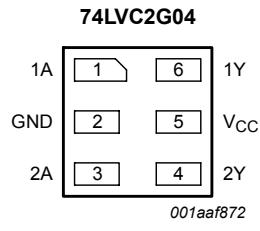


Figure 6. Pin configuration SOT891, SOT1115 and SOT1202

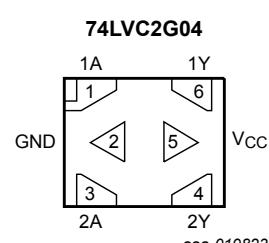


Figure 7. Pin configuration SOT1255 (X2SON6)

6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
1A	1	data input
GND	2	ground (0 V)
2A	3	data input
2Y	4	data output
V _{CC}	5	supply voltage
1Y	6	data output

7 Functional description

Table 4. Function table ^[1]

Input	Output
nA	nY
L	H
H	L

[1] H = HIGH voltage level; L = LOW voltage level.

8 Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CC}	supply voltage		-0.5	+6.5	V	
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA	
V _I	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	V _O > V _{CC} or V _O < 0 V	-	±50	mA	
V _O	output voltage	Active mode	[1] [2]	-0.5	V _{CC} + 0.5	V
		Power-down mode	[1] [2]	-0.5	+6.5	V
I _O	output current	V _O = 0 V to V _{CC}	-	±50	mA	
I _{CC}	supply current		-	100	mA	
I _{GND}	ground current		-100	-	mA	
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[3]	-	250	mW
T _{stg}	storage temperature		-65	+150	°C	

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When V_{CC} = 0 V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For SC-88 and SC-74 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.

For X2SON6 and XSON6 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9 Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.65	-	5.5	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage	Active mode	0	-	V_{CC}	V
		Power-down mode; $V_{CC} = 0$ V	0	-	5.5	V
T_{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65$ V to 2.7 V	-	-	20	ns/V
		$V_{CC} = 2.7$ V to 5.5 V	-	-	10	ns/V

10 Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C	Unit
			Min	Typ [1]	Max		
V_{IH}	HIGH-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	0.65 V_{CC}	-	-	0.65 V_{CC}	-
		$V_{CC} = 2.3$ V to 2.7 V	1.7	-	-	1.7	-
		$V_{CC} = 2.7$ V to 3.6 V	2.0	-	-	2.0	-
		$V_{CC} = 4.5$ V to 5.5 V	0.7 V_{CC}	-	-	0.7 V_{CC}	-
V_{IL}	LOW-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	-	-	0.35 V_{CC}	-	0.35 V_{CC}
		$V_{CC} = 2.3$ V to 2.7 V	-	-	0.7	-	0.7
		$V_{CC} = 2.7$ V to 3.6 V	-	-	0.8	-	0.8
		$V_{CC} = 4.5$ V to 5.5 V	-	-	0.3 V_{CC}	-	0.3 V_{CC}
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = -100$ µA; $V_{CC} = 1.65$ V to 5.5 V	$V_{CC} - 0.1$	-	-	$V_{CC} - 0.1$	-
		$I_O = -4$ mA; $V_{CC} = 1.65$ V	1.2	-	-	0.95	-
		$I_O = -8$ mA; $V_{CC} = 2.3$ V	1.9	-	-	1.7	-
		$I_O = -12$ mA; $V_{CC} = 2.7$ V	2.2	-	-	1.9	-
		$I_O = -24$ mA; $V_{CC} = 3.0$ V	2.3	-	-	2.0	-
		$I_O = -32$ mA; $V_{CC} = 4.5$ V	3.8	-	-	3.4	-
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = 100$ µA; $V_{CC} = 1.65$ V to 5.5 V	-	-	0.10	-	0.10
		$I_O = 4$ mA; $V_{CC} = 1.65$ V	-	-	0.45	-	0.70
		$I_O = 8$ mA; $V_{CC} = 2.3$ V	-	-	0.30	-	0.45
		$I_O = 12$ mA; $V_{CC} = 2.7$ V	-	-	0.40	-	0.60

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.80 V
		$I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	-	0.80 V
I_I	input leakage current	$V_I = 5.5 \text{ V or GND}; V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	± 0.1	± 1	-	$\pm 1 \mu\text{A}$
I_{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_I \text{ or } V_O = 5.5 \text{ V}$	-	± 0.1	± 2	-	$\pm 2 \mu\text{A}$
I_{CC}	supply current	$V_I = 5.5 \text{ V or GND}; I_O = 0 \text{ A}; V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	0.1	4	-	4 μA
ΔI_{CC}	additional supply current	per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V}; V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	-	500 μA
C_I	input capacitance	$V_{CC} = 3.3 \text{ V}; V_I = \text{GND to } V_{CC}$	-	2.5	-	-	- pF

[1] All typical values are measured at $V_{CC} = 3.3 \text{ V}$ and $T_{amb} = 25 \text{ °C}$.

11 Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	
t_{pd}	propagation delay	$nA \text{ to } nY$; see Figure 8 [2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.0	3.5	8.0	1.0	9.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.2	4.4	1.0	5.4	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	2.7	5.2	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.5	2.7	4.1	0.5	5.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.0	1.9	3.2	1.0	3.8	ns
C_{PD}	power dissipation capacitance	$V_I = \text{GND to } V_{CC}; V_{CC} = 3.3 \text{ V}$ [3]	-	13.5	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$ and $V_{CC} = 1.8 \text{ V}, 2.5 \text{ V}, 2.7 \text{ V}, 3.3 \text{ V}$ and 5.0 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

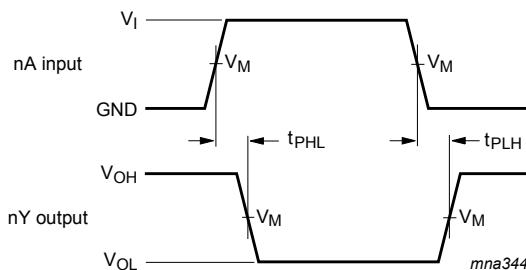
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

11.1 Waveforms and test circuit



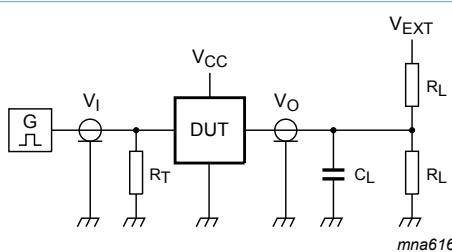
Measurement points are given in [Table 9](#).

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 8. The input nA to output nY propagation delays

Table 9. Measurement points

Supply voltage	Input	Output
V_{CC}	V_M	V_M
1.65 V to 1.95 V	0.5 V_{CC}	0.5 V_{CC}
2.3 V to 2.7 V	0.5 V_{CC}	0.5 V_{CC}
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	0.5 V_{CC}	0.5 V_{CC}



Test data is given in [Table 10](#).

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Figure 9. Test circuit for measuring switching times

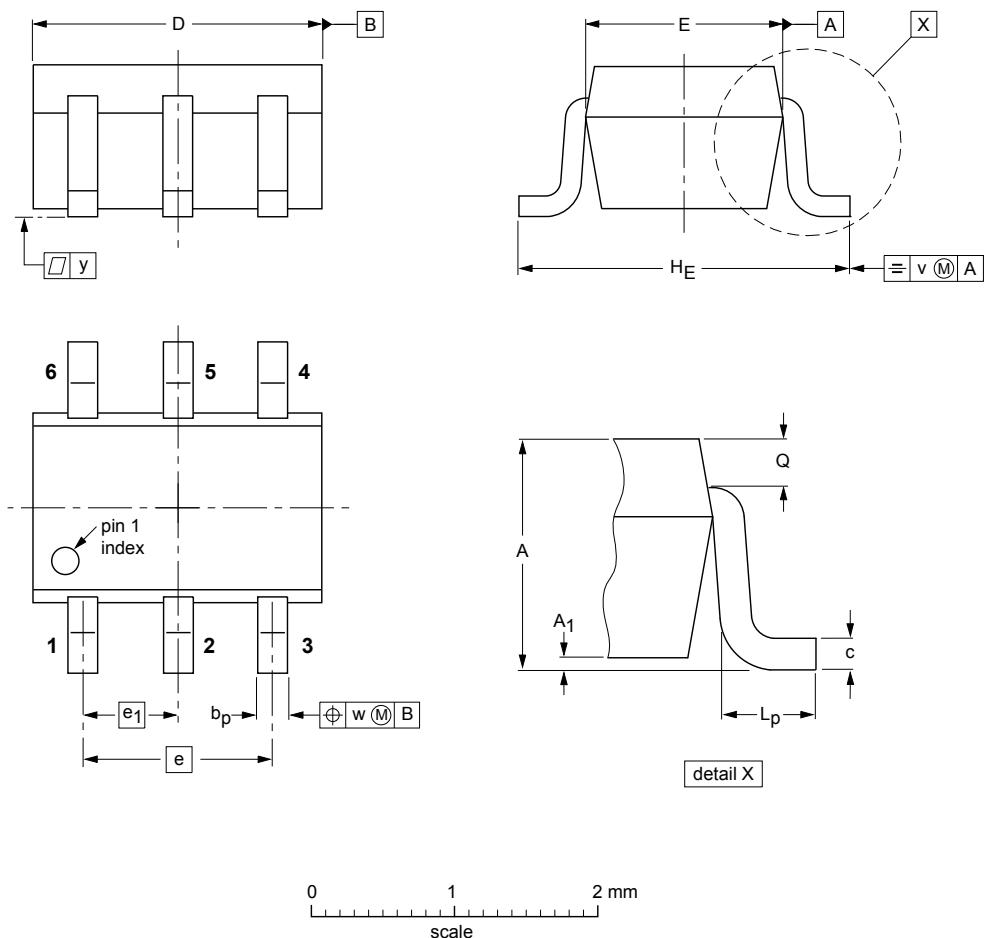
Table 10. Test data

Supply voltage	Input		Load		V_{EXT}
V_{CC}	V_I	$t_r = t_f$	C_L	R_L	t_{PLH}, t_{PHL}
1.65 V to 1.95 V	V_{CC}	≤ 2.0 ns	30 pF	1 k Ω	open
2.3 V to 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open

12 Package outline

Plastic surface-mounted package; 6 leads

SOT363



DIMENSIONS (mm are the original dimensions)

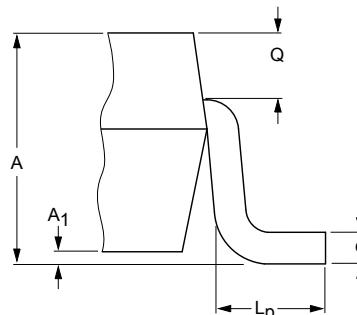
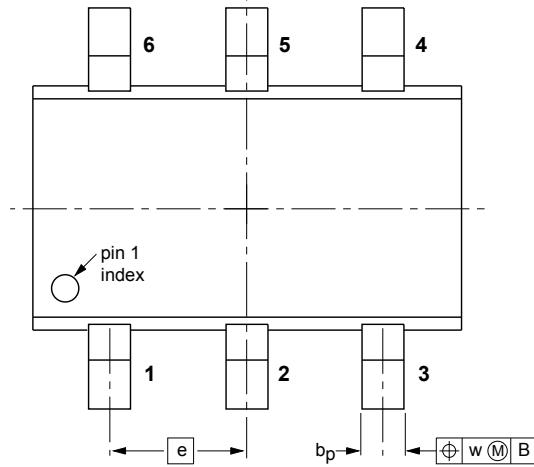
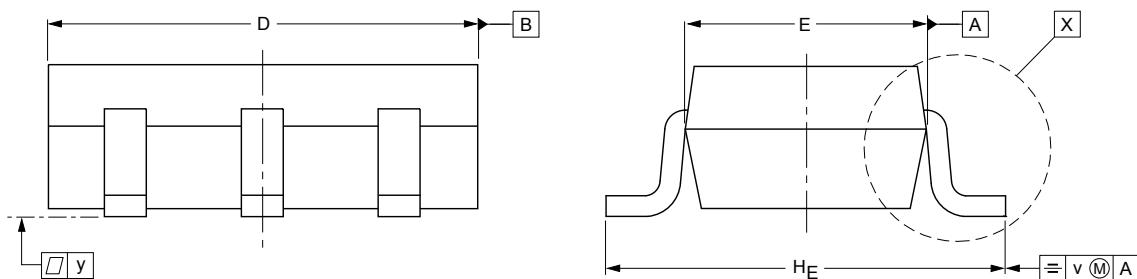
UNIT	A	A_1 max	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA	SC-88		
SOT363						04-11-08- 06-03-16

Figure 10. Package outline SOT363 (SC-88)

Plastic surface-mounted package (TSOP6); 6 leads

SOT457



0 1 2 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b _p	c	D	E	e	H _E	L _p	Q	v	w	y
mm	1.1 0.9	0.1 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT457			SC-74			-05-11-07 06-03-16

Figure 11. Package outline SOT457 (SC-74)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

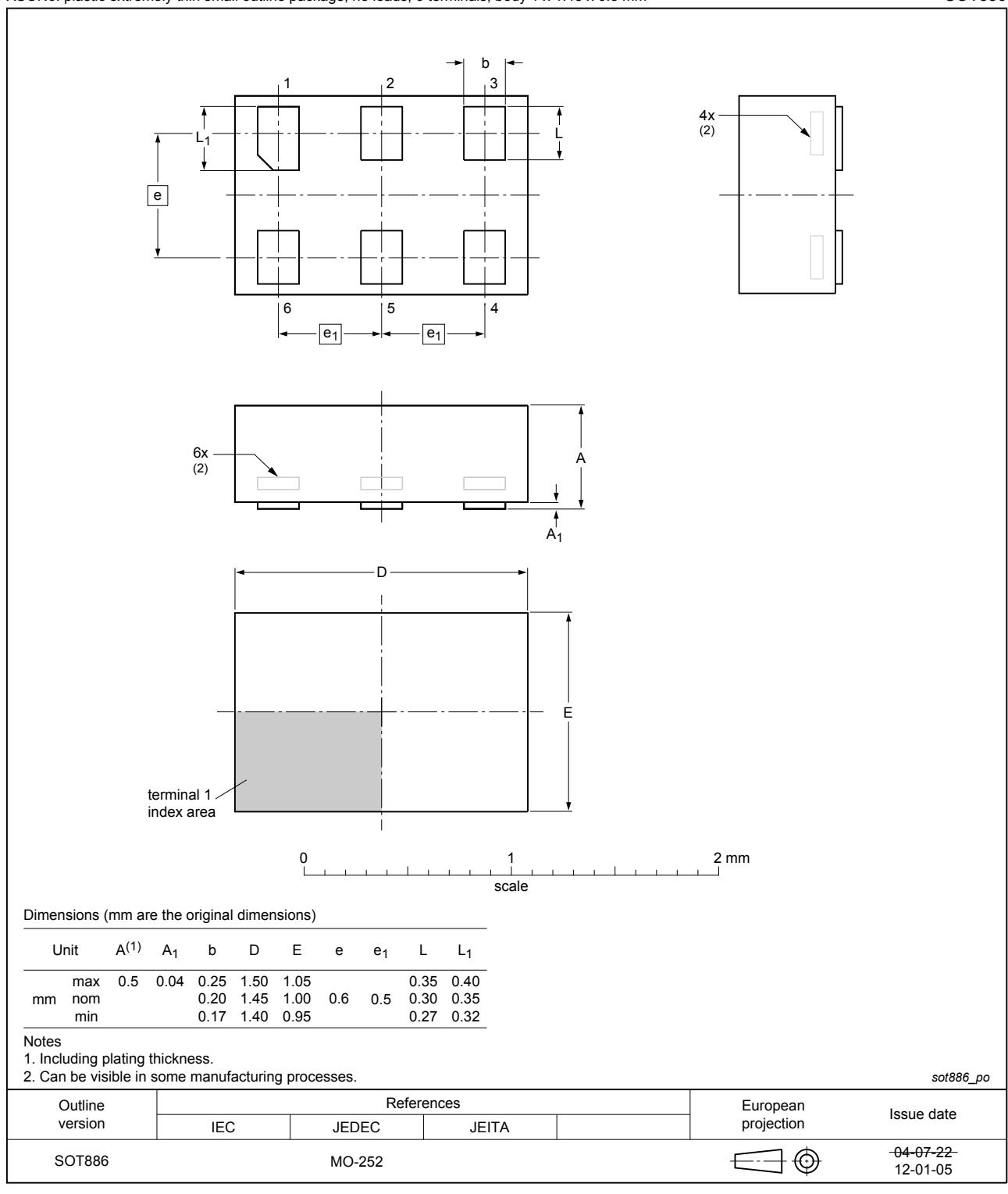
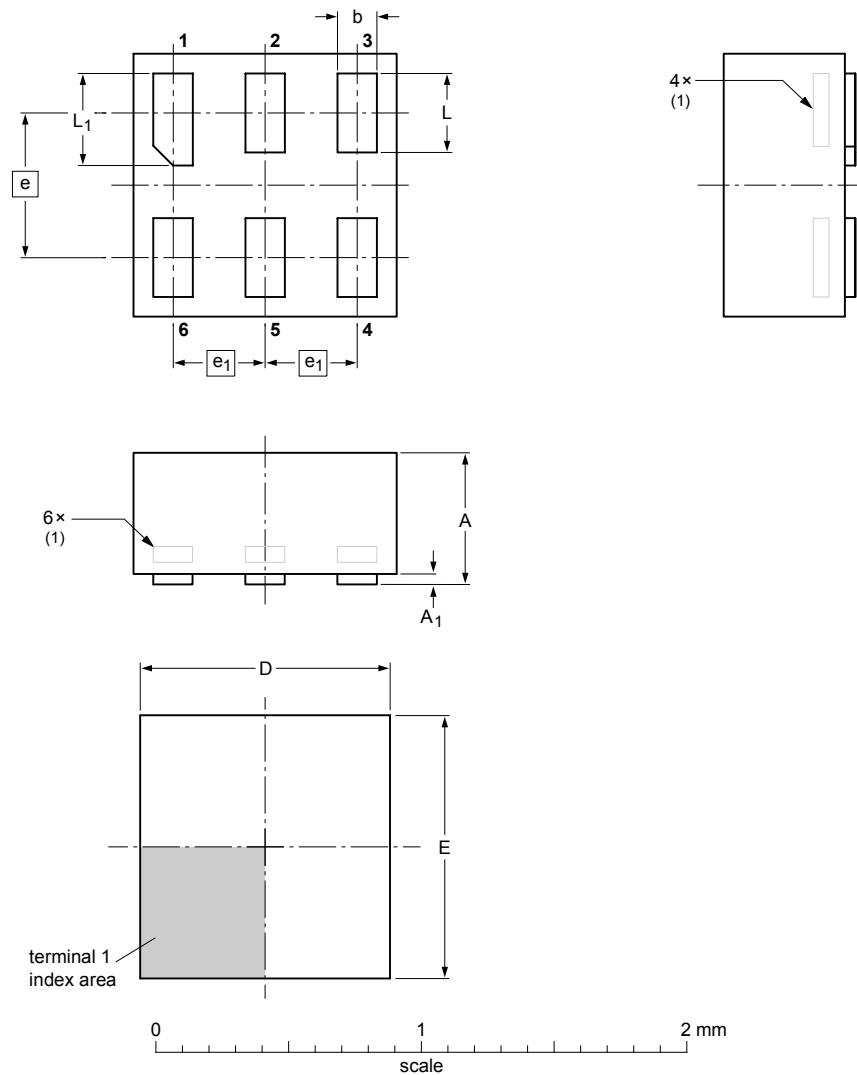


Figure 12. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm

SOT891



DIMENSIONS (mm are the original dimensions)

UNIT	A max	A1 max	b	D	E	e	e1	L	L1
mm	0.5	0.04	0.20 0.12	1.05 0.95	1.05 0.95	0.55	0.35	0.35 0.27	0.40 0.32

Note

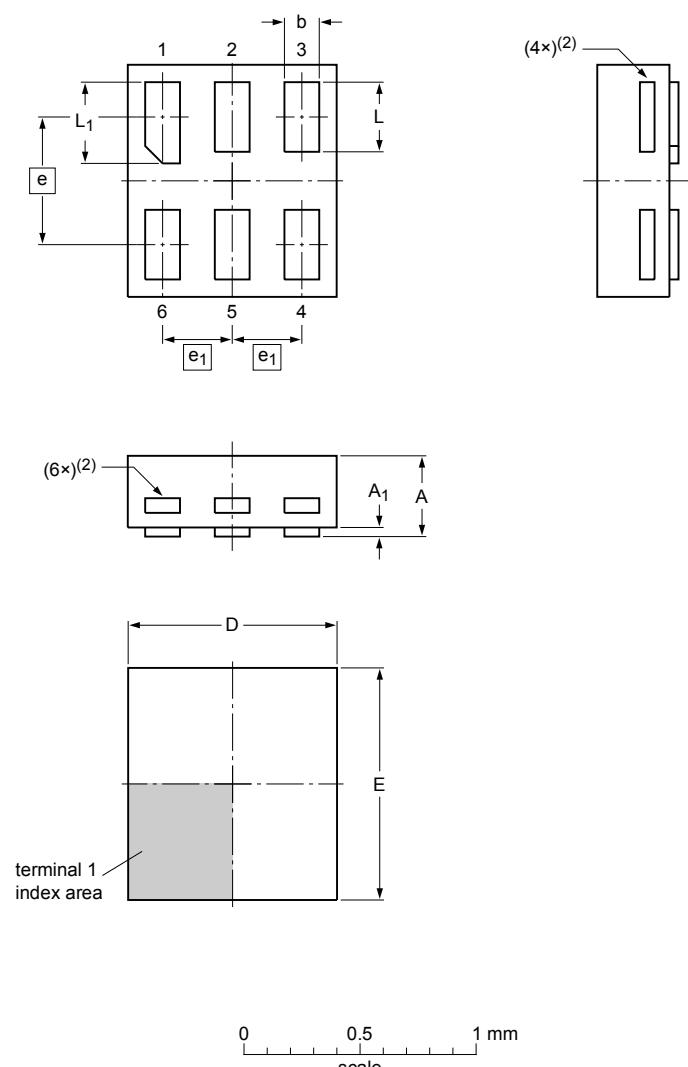
1. Can be visible in some manufacturing processes.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT891					-05-04-06 07-05-15

Figure 13. Package outline SOT891 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 0.9 x 1.0 x 0.35 mm

SOT1115



Dimensions

Unit	A ⁽¹⁾	A ₁	b	D	E	e	e ₁	L	L ₁
mm	max	0.35	0.04	0.20	0.95	1.05		0.35	0.40
mm	nom			0.15	0.90	1.00	0.55	0.3	0.35
mm	min			0.12	0.85	0.95		0.27	0.32

Note

1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1115_po

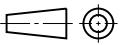
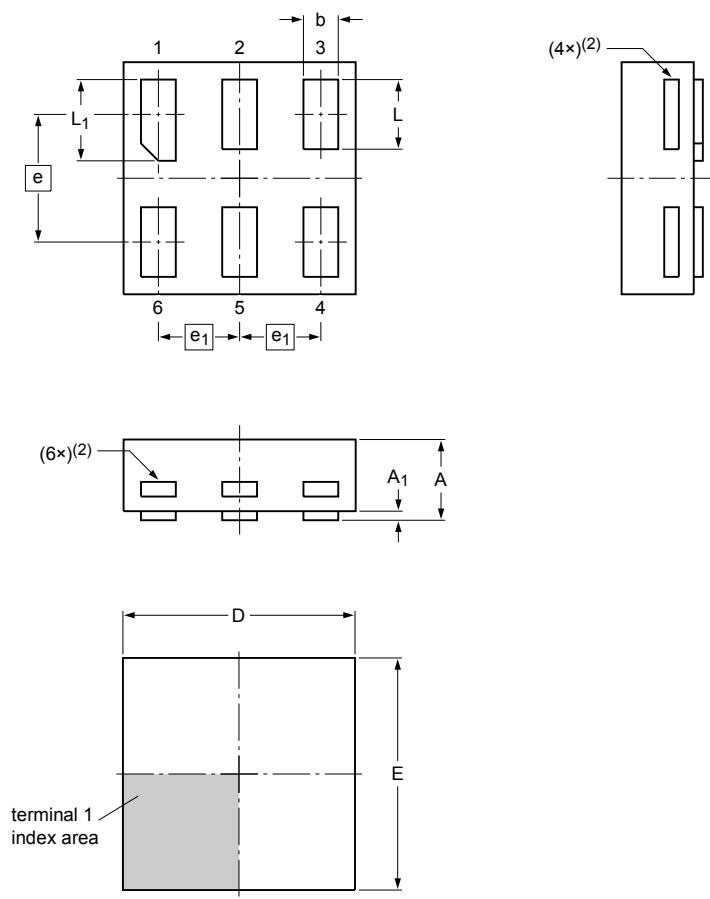
Outline version	References			European projection	Issue date
	IEC	JEDEC	JEITA		
SOT1115					10-04-02 10-04-07

Figure 14. Package outline SOT1115 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 1.0 x 1.0 x 0.35 mm

SOT1202



Dimensions

Unit	A ⁽¹⁾	A ₁	b	D	E	e	e ₁	L	L ₁
mm	max	0.35	0.04	0.20	1.05	1.05		0.35	0.40
mm	nom			0.15	1.00	1.00	0.55	0.35	0.35
mm	min			0.12	0.95	0.95		0.27	0.32

Note

1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1202_po

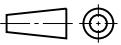
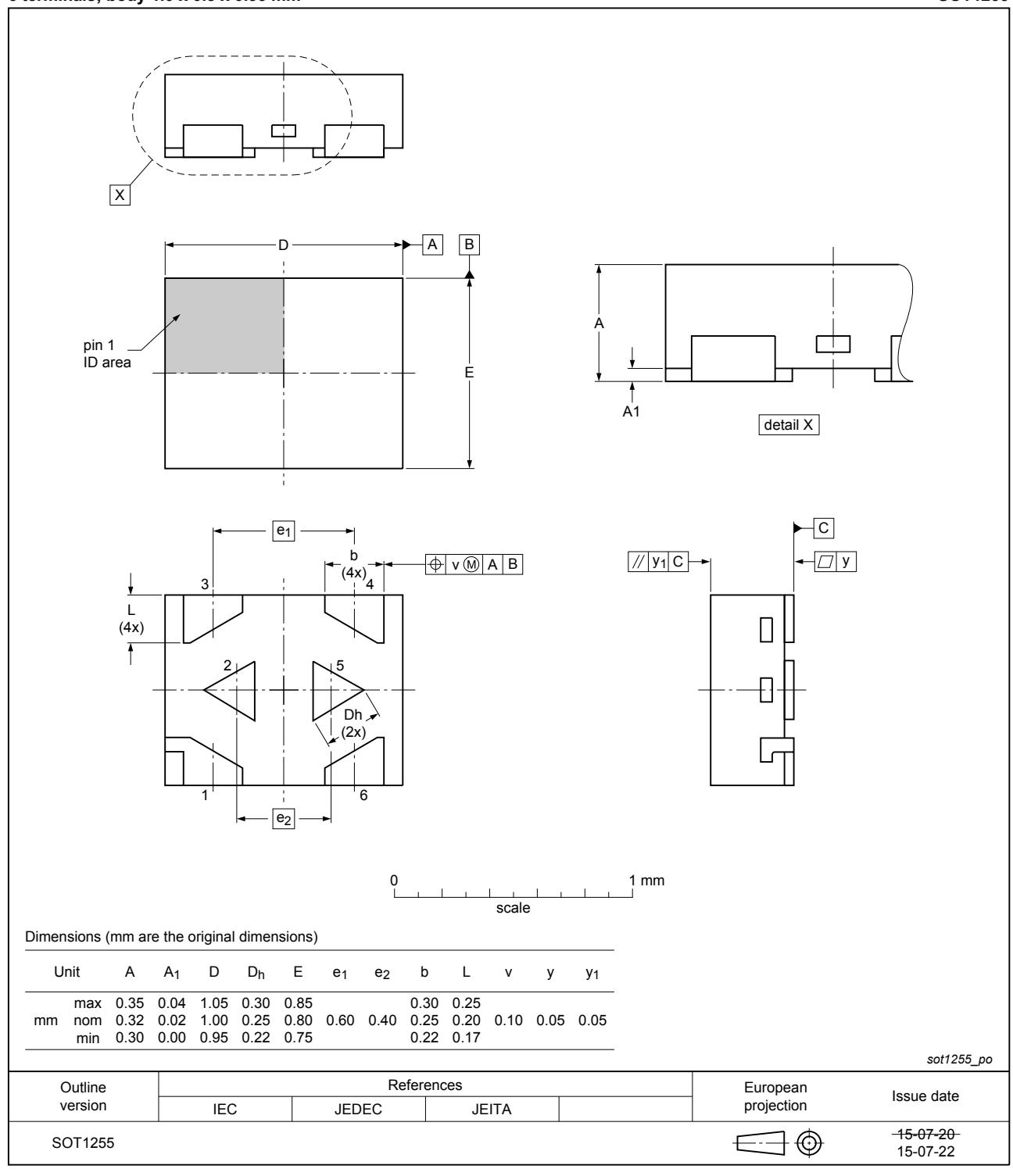
Outline version	References			European projection	Issue date
	IEC	JEDEC	JEITA		
SOT1202					10-04-02 10-04-06

Figure 15. Package outline SOT1202 (XSON6)

X2SON6: plastic thermal enhanced extremely thin small outline package; no leads;
6 terminals; body 1.0 x 0.8 x 0.35 mm

SOT1255



13 Abbreviations

Table 11. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14 Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2G04 v.10	20170522	Product data sheet	-	74LVC2G04 v.9
Modifications:	<ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Pin 6 description updated. Section 6.2 			
74LVC2G04 v.9	20161212	Product data sheet	-	74LVC2G04 v.8
Modifications:	<ul style="list-style-type: none"> Table 7: The maximum limits for leakage current and supply current have changed. 			
74LVC2G04 v.8	20150917	Product data sheet	-	74LVC2G04 v.7
Modifications:	<ul style="list-style-type: none"> Added type number 74LVC2G04GX (SOT1255/X2SON6). 			
74LVC2G04 v.7	20140910	Product data sheet	-	74LVC2G04 v.6
Modifications:	<ul style="list-style-type: none"> Package outline drawing of SOT886 (Figure 12) modified. 			
74LVC2G04 v.6	20111206	Product data sheet	-	74LVC2G04 v.5
74LVC2G04 v.5	20100805	Product data sheet	-	74LVC2G04 v.4
74LVC2G04 v.4	20070725	Product data sheet	-	74LVC2G04 v.3
74LVC2G04 v.3	20070216	Product data sheet	-	74LVC2G04 v.2
74LVC2G04 v.2	20040915	Product specification	-	74LVC2G04 v.1
74LVC2G04 v.1	20030722	Product specification	-	-

15 Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

15.2 Definitions

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